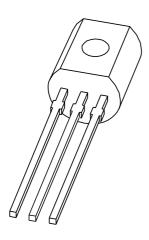
DISCRETE SEMICONDUCTORS

DATA SHEET



MPS3906 PNP switching transistor

Product specification Supersedes data of 1999 Apr 12

2004 Oct 27





PNP switching transistor

MPS3906

FEATURES

- Low current (max. 100 mA)
- Low voltage (max. 40 V).

APPLICATIONS

• General purpose switching and amplification.

DESCRIPTION

PNP transistor in a plastic TO-92; SOT54 package. NPN complement: MPS3904.

PINNING

PIN	DESCRIPTION
1	collector
2	base
3	emitter

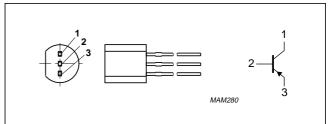


Fig.1 Simplified outline (TO-92; SOT54) and symbol.

ORDERING INFORMATION

TYPE NUMBER		PACKAGE					
ITPE NOWIBER	NAME DESCRIPTION VERSION						
MPS3906	SC-43A	plastic single-ended leaded (through hole) package; 3 leads	SOT54				

LIMITING VALUES

In accordance with the Absolute Maximum Rating System (IEC 60134).

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT
V _{CBO}	collector-base voltage	open emitter	_	-40	V
V _{CEO}	collector-emitter voltage	open base	_	-40	V
V _{EBO}	emitter-base voltage	open collector	_	- 5	V
I _C	collector current (DC)		_	-100	mA
I _{CM}	peak collector current		_	-200	mA
I _{BM}	peak base current		_	-200	mA
P _{tot}	total power dissipation	T _{amb} ≤ 25 °C	_	500	mW
T _{stg}	storage temperature		-65	+150	°C
Tj	junction temperature		_	150	°C
T _{amb}	ambient temperature		-65	+150	°C

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THERMAL CHARACTERISTICS

SYMBOL	PARAMETER	CONDITIONS	VALUE	UNIT
R _{th(j-a)}	thermal resistance from junction to ambient	note 1	250	K/W

Note

1. Transistor mounted on an FR4 printed-circuit board.

CHARACTERISTICS

 T_{amb} = 25 °C unless otherwise specified.

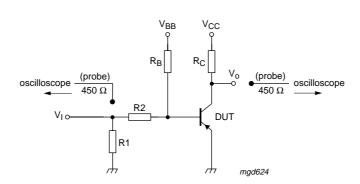
SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT
I _{CBO}	collector-base cut-off current	$V_{CB} = -30 \text{ V}; I_{E} = 0 \text{ A}$	-	-50	nA
I _{EBO}	emitter-base cut-off current	$V_{EB} = -5 \text{ V}; I_{E} = 0 \text{ A}$	_	-50	nA
h _{FE}	DC current gain	V _{CE} = −1 V; note 1			
		$I_{\rm C} = -0.1 \text{mA}$	60	_	
		$I_C = -1 \text{ mA}$	80	_	
		$I_C = -10 \text{ mA}$	100	300	
		$I_{\rm C} = -50 \text{mA}$	60	_	
		$I_{\rm C} = -100 \text{mA}$	30	_	
V _{CEsat}	collector-emitter saturation voltage	$I_C = -10 \text{ mA}$; $I_B = -1 \text{ mA}$; note 1	_	-250	mV
		$I_C = -50 \text{ mA}$; $I_B = -5 \text{ mA}$; note 1	_	-400	mV
V _{BEsat}	base-emitter saturation voltage	$I_C = -10 \text{ mA}$; $I_B = -1 \text{ mA}$; note 1	-650	-850	mV
		$I_C = -50 \text{ mA}$; $I_B = -5 \text{ mA}$; note 1	_	-950	mV
C _c	collector capacitance	$V_{CB} = -5 \text{ V}; I_E = i_e = 0 \text{ A};$ f = 100 kHz to 1 MHz	_	5	pF
C _e	emitter capacitance	$V_{EB} = -0.5 \text{ V}; I_C = I_c = 0 \text{ A};$ f = 100 kHz to 1 MHz	_	15	pF
f _T	transition frequency	$V_{CE} = -20 \text{ V}; I_{C} = -10 \text{ mA}; f = 100 \text{ MHz}$	150	_	MHz
F	noise figure	V_{CE} = -5 V; I_{C} = -100 μA; R_{S} = 1 kΩ; f = 10 Hz to 15.7 kHz	_	4	dB
Switching t	imes (between 10 % and 90 % levels	s); (see Fig.2)	•		•
t _{on}	turn-on time	$I_{Bon} = -10 \text{ mA}; I_{Bon} = -1 \text{ mA};$	_	100	ns
t _d	delay time	$I_{Boff} = 1 \text{ mA}; V_{CC} = -3 \text{ V}; V_{BB} = 1.9 \text{ V}$	_	50	ns
t _r	rise time	1	_	50	ns
t _{off}	turn-off time]	_	700	ns
t _s	storage time	1	_	600	ns
t _f	fall time]	_	100	ns

Note

1. Pulse test: t_p = 300 μ s; δ = 0.02.

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 $V_i = -5 \ V; \ t_p \geq 4 \ \mu s; \ t_r = t_f \leq 3 \ ns.$

R1 = 56 Ω ; R2 = 2.5 k Ω ; R_B = 3.9 k Ω ; R_C = 270 Ω .

Oscilloscope: input impedance $Z_i = 50 \Omega$.

Fig.2 Test circuit for switching times.

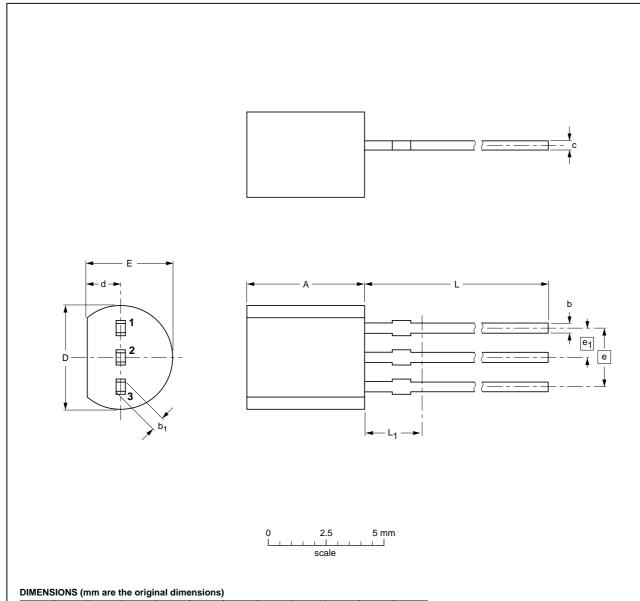
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PACKAGE OUTLINE

Plastic single-ended leaded (through hole) package; 3 leads

SOT54



UNIT	A	b	b ₁	С	D	d	E	е	e ₁	L	L ₁ ⁽¹⁾ max.	
mm	5.2 5.0	0.48 0.40	0.66 0.55	0.45 0.38	4.8 4.4	1.7 1.4	4.2 3.6	2.54	1.27	14.5 12.7	2.5	

Note

1. Terminal dimensions within this zone are uncontrolled to allow for flow of plastic and terminal irregularities.

OUTLINE		REFER	EUROPEAN	ISSUE DATE		
VERSION	IEC	JEDEC	JEITA		PROJECTION	
SOT54		TO-92	SC-43A			97-02-28 04-06-28

PNP switching transistor

MPS3906

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LEVEL	DATA SHEET STATUS ⁽¹⁾	PRODUCT STATUS(2)(3)	DEFINITION
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